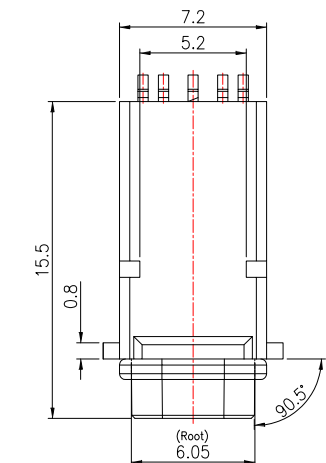
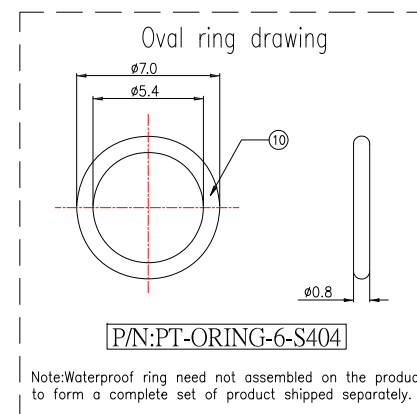
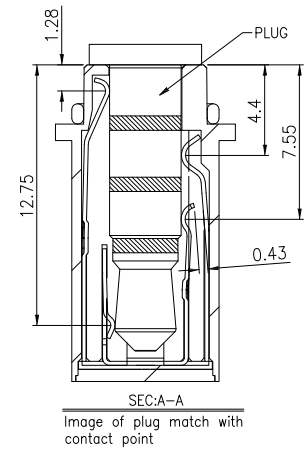
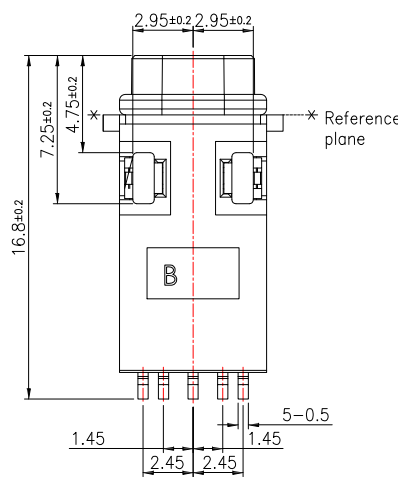


Recommended PCB Layout
(Top view)



⑩	OVAL RING	----	1	SILICONE	
⑨	BOND	----	1	EPOXY	----
⑧	TERMINAL	----	2	C2680	Gold PLATED ,Nickel Underplate
⑦	TIP SPRING-2	⑤	1	Ti-Cu	
⑥	RING SPRING-2	④	1	Ti-Cu	
⑤	RING SPRING-1	③	1	Ti-Cu	
④	TIP SPRING-1	②	1	Ti-Cu	
③	EARTH SPRING	①	1	Ti-Cu	
②	COVER	----	1	PA9T	
①	HOUSING	----	1	PA9T	
ITEM	PART NAME	TERMINAL	QTY	MATERIAL	REMARK

				建倚科技股份有限公司 CONTACT TECHNOLOGY CORP.				DRAWN BY: DATE		MATL		TITLE	JACK	
								Jack Lu	04/12/19		FINISH		MODLE	3.5mm PHONE JACK 防水型
								TOLERANCE UNLESS OTHERWISE STATED: Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3°				CHECKED BY: DATE		SCALE
				Jacky Chen	04/12/19	APPROVED BY: DATE						SHEET NO.	1 of 1	
ITEM NO.	DESCRIPTION	DRAWN	DATE	3RD.		UNITS	MM	Tony Kao	04/12/19					
	A	B		C	D	E	F	G	H	I	J			